

PAT-NO: JP02002289560A
DOCUMENT-IDENTIFIER: JP 2002289560 A
TITLE: IN-PRINT METHOD AND IN-PRINT DEVICE
PUBN-DATE: October 4, 2002

INVENTOR-INFORMATION:

NAME	COUNTRY
DEGUCHI, KIMIKICHI	N/A
TAKEUCHI, NOBUYUKI	N/A
SHIMIZU, AKIRA	N/A

ASSIGNEE-INFORMATION:

NAME	COUNTRY
NIPPON TELEGR & TELEPH CORP	N/A

APPL-NO: JP2001084681
APPL-DATE: March 23, 2001

INT-CL (IPC): H01L021/30 , B30B015/02

ABSTRACT:

PROBLEM TO BE SOLVED: To provide an in-print method and an in-print device with which a mold pattern can be transferred all over the press plane with high uniformity by equally pressing the mold pattern of a wide area.

SOLUTION: In the in-print method and the in-print device for transferring a mold pattern 4 on a film 6 for wafer working by pressing the mold pattern 4 formed on a mold wafer 3 on the film 6 for wafer working formed on a wafer 5, the height of the mold pattern 4 in the pressing direction is decreased from the center of the press plane to the peripheral edge, and non-uniformity in a pressure on the press plane in the case of pressing is lowered in comparison with the case of no decrease in the height.

COPYRIGHT: (C) 2002, JPO